SMD Power Inductor

TMIM-Series(G)

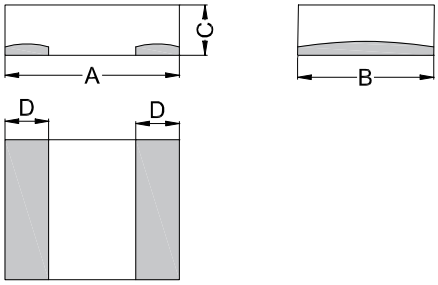
1. Features

1. Low loss realized with low DCR.
2. High performance realized by metal dust core.
3. Ultra low buzz noise, due to composite construction.
4. 100% Lead(Pb)-Free and RoHS compliant.

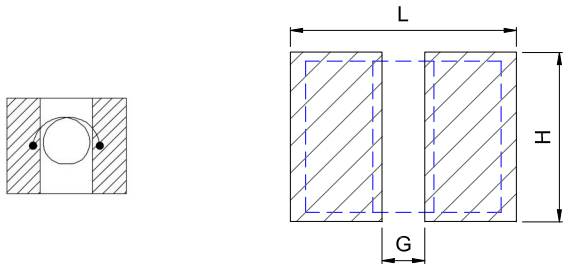
2. Applications

Commercial applications

3. Dimensions



Recommend PC Board Pattern



Series	A(mm)	B(mm)	C(mm)	D(mm)	L(mm)	G(mm)	H(mm)
TMIM201610A	2.0±0.3	1.6±0.3	0.8±0.2	0.7±0.3	2.5 Ref	0.5 Ref	1.9 Ref
TMIM201612A	2.0±0.3	1.6±0.3	1.0±0.2	0.7±0.3	2.5 Ref	0.5 Ref	1.9 Ref
TMIM252010A	2.5±0.3	2.0±0.3	0.8±0.2	0.9±0.3	2.9 Ref	0.5 Ref	2.3 Ref
TMIM252012A	2.5±0.3	2.0±0.3	1.0±0.2	0.9±0.3	2.9 Ref	0.5 Ref	2.3 Ref
TMIM322510A	3.2±0.3	2.5±0.3	0.8±0.2	1.1±0.3	3.7 Ref	0.7 Ref	2.8 Ref
TMIM322512A	3.2±0.3	2.5±0.3	1.0±0.2	1.1±0.3	3.7 Ref	0.7 Ref	2.8 Ref
TMIM322520A	3.2±0.3	2.5±0.3	1.8±0.2	1.1±0.3	3.7 Ref	0.7 Ref	2.8 Ref

4. Part Numbering

TMIM	201610	A	-	R33	-	M	-	G
A	B	C		D		E		F

A: Series
B: Dimension AxBxC
C: Material
D: Inductance R33=0.33uH
E: Inductance Tolerance M=±20%
F: Coating

5.Specification

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM201610A-R10MG	0.10	8.0	7.0	9.0	8.0	7.5	9.0
TMIM201610A-R22MG	0.22	7.0	6.0	8.0	7.0	10.5	12.6
TMIM201610A-R24MG	0.24	6.5	5.5	7.7	6.7	18.0	20.5
TMIM201610A-R33MG	0.33	5.7	5.2	7.0	6.2	21.0	26.0
TMIM201610A-R47MG	0.47	5.3	4.7	6.0	5.3	28.0	32.0
TMIM201610A-R56MG	0.56	4.6	4.0	5.2	4.6	31.0	37.2
TMIM201610A-R68MG	0.68	4.0	3.4	5.0	4.4	44.0	50.0
TMIM201610A-1R0MG	1.00	3.6	3.2	4.4	3.8	49.0	59.0
TMIM201610A-1R5MG	1.50	2.6	2.3	3.0	2.7	80.0	96.0
TMIM201610A-2R2MG	2.20	2.3	2.0	2.65	2.45	130.0	150.0
TMIM201610A-4R7MG	4.70	1.4	1.2	2.1	1.9	265.0	318.0

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM201612A-R22MG	0.22	7.0	6.0	8.0	7.0	10.0	13.0
TMIM201612A-R33MG	0.33	5.9	5.3	7.0	6.2	15.0	18.0
TMIM201612A-R47MG	0.47	5.4	4.8	6.0	5.3	20.0	26.0
TMIM201612A-R68MG	0.68	4.2	3.7	5.0	4.4	30.0	36.0
TMIM201612A-1R0MG	1.00	3.7	3.3	4.5	4.0	40.0	48.0
TMIM201612A-1R5MG	1.50	2.9	2.5	3.1	2.8	70.0	84.0
TMIM201612A-2R2MG	2.20	2.5	2.1	2.7	2.5	105.0	126.0

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM252010A-R22MG	0.22	7.2	6.6	7.7	7.0	12	15
TMIM252010A-R33MG	0.33	6.6	6.0	7.2	6.4	16	19
TMIM252010A-R47MG	0.47	5.8	5.1	6.0	5.4	20	24
TMIM252010A-R68MG	0.68	5.1	4.7	5.2	4.8	25	30
TMIM252010A-1R0MG	1.00	4.3	4.0	4.6	3.8	42	50.4
TMIM252010A-1R5MG	1.50	3.3	3.0	3.5	3.2	60	72
TMIM252010A-2R2MG	2.20	2.8	2.5	3.0	2.7	85	102
TMIM252010A-3R3MG	3.30	2.0	1.7	2.1	1.8	130	156

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM252012A-R15MG	0.15	9.0	8.0	11.0	10.0	8.0	9.6
TMIM252012A-R24MG	0.24	7.3	6.8	7.8	7.2	11.0	13.2
TMIM252012A-R33MG	0.33	6.8	6.3	7.5	6.8	14.0	17.0
TMIM252012A-R47MG	0.47	6.2	5.6	6.2	5.6	15.0	18.0
TMIM252012A-R56MG	0.56	5.9	5.4	5.9	5.4	20.0	24.0
TMIM252012A-R68MG	0.68	5.3	4.9	5.5	5.0	23.0	27.6
TMIM252012A-1R0MG	1.00	4.5	4.2	5.0	4.2	33.0	39.6
TMIM252012A-1R5MG	1.50	3.7	3.4	4.0	3.5	43.0	51.6
TMIM252012A-2R2MG	2.20	3.1	2.8	3.4	3.1	66.0	79.2
TMIM252012A-3R3MG	3.30	2.4	2.2	3.0	2.7	115	138
TMIM252012A-4R7MG	4.70	2.0	1.8	2.8	2.5	170	204

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM322510A-R33MG	0.33	7.0	6.0	8.0	7.0	15.0	18.0
TMIM322510A-R47MG	0.47	6.0	5.5	6.5	5.5	18.0	21.6
TMIM322510A-R68MG	0.68	5.5	5.0	6.0	5.2	22.0	26.4
TMIM322510A-1R0MG	1.00	4.8	4.0	4.8	4.0	30.0	36.0
TMIM322510A-1R5MG	1.50	3.8	3.2	4.3	3.8	48.3	58.0
TMIM322510A-2R2MG	2.20	3.1	2.7	3.6	3.3	67.0	80.4
TMIM322510A-3R3MG	3.30	2.5	2.1	3.1	2.8	100.0	120.0
TMIM322510A-4R7MG	4.70	2.0	1.7	2.2	1.9	143.0	172.0

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM322512A-R15MG	0.15	10.1	9.5	11.0	10.0	6.5	7.8
TMIM322512A-R22MG	0.22	9.5	9.0	9.3	8.7	7.4	8.5
TMIM322512A-R33MG	0.33	8.5	8.0	9.1	8.5	10.0	13.0
TMIM322512A-R47MG	0.47	7.0	6.5	8.2	7.4	16.0	19.2
TMIM322512A-R68MG	0.68	6.2	5.7	7.3	6.8	20.0	24.0
TMIM322512A-1R0MG	1.00	5.5	5.0	6.5	5.7	26.0	32.0
TMIM322512A-1R2MG	1.2	4.9	4.4	5.8	5.1	33.0	40.0
TMIM322512A-1R5MG	1.50	4.4	3.9	5.0	4.5	44.0	53.0
TMIM322512A-2R2MG	2.20	4.0	3.6	4.8	4.3	61.0	73.0
TMIM322512A-3R3MG	3.30	3.1	2.8	3.4	3.0	87.0	101.0
TMIM322512A-4R7MG	4.70	2.2	1.9	2.8	2.4	122.0	146.0

Part Number	Inductance L0 A(uH) ±20%	Irms(A)		I sat (A)		DCR (mΩ) Typ	DCR (mΩ) Max
		Typ	Max	Typ	Max		
TMIM322520A-R33MG	0.33	8.5	8.0	11.0	10.0	8.0	9.6
TMIM322520A-R47MG	0.47	8.0	7.5	9.0	8.0	9.3	11.2
TMIM322520A-R56MG	0.56	7.5	7.0	8.5	7.5	11.4	13.7
TMIM322520A-R68MG	0.68	7.0	6.4	8.0	7.0	13.3	16.0
TMIM322520A-1R0MG	1.00	6.2	5.8	7.5	6.2	18.3	22.0
TMIM322520A-1R5MG	1.50	5.3	4.8	6.0	5.0	25.8	31.0
TMIM322520A-2R2MG	2.20	3.7	3.2	5.0	4.5	38.0	46.0
TMIM322520A-3R3MG	3.30	3.2	2.7	4.2	3.7	56.0	65.0
TMIM322520A-4R7MG	4.70	2.8	2.4	3.4	2.9	90.0	98.0

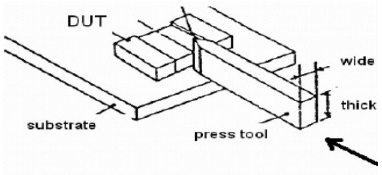
Note:

1. Test frequency : Ls : 100KHz /1.0V.
2. All test data referenced to 25℃ ambient.
3. Testing Instrument(or equ) : Agilent 4284A,E4991A,4339B,KEYSIGHT E4980A/AL,chroma3302,3250,16502.
4. Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40℃
5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
6. The part temperature (ambient + temp rise) should not exceed 125℃under worst case operating conditions.Circuit design,component,PCB trace size and thickness,airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
7. Irms Testing : Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.
8. Rated DC current: The lower value of Irms and Isat.
9. Rated voltage 25V DC,The application of voltage depends on many factors，Over voltage may cause components failure、high temperature and burn-out,User needs to verify for appropriate usage.

6. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125℃ (Including self - temperature rise)	
Storage temperature	1. -10~+40℃,50~60%RH (Product without taping) 2. -40~+125℃(on board)	
Electrical Performance Test		
Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR		CH16502,Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately △L30%.	Saturation DC Current (Isat) will cause L0 to drop △L(%)
Heat Rated Current (Irms)	Approximately △T40℃	Heat Rated Current (Irms) will cause the coil temperature rise △T(℃). 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer
Reliability Test		
Life Test	Appearance：No damage. Inductance：within±10% of initial value Q：Shall not exceed the specification value. RDC：within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 3times. (IPC/JEDECJ-STD-020E Classification Reflow Profiles) Temperature： 125±2℃(Inductor，ambient + temp rise) Applied current：rated current Duration：1000±12hrs Measured at room temperature after placing for 24±2 hrs.
Load Humidity		Preconditioning: Run through IR reflow for 3times. (IPC/JEDECJ-STD-020E Classification Reflow Profiles) Humidity：85±2％R.H, Temperature：85℃±2℃ Duration：1000hrs Min. Bead:with 100% rated current, Inductance：with 100% rated current Measured at room temperature after placing for 24±2 hrs.
Moisture Resistance		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDECJ-STD-020E Classification Reflow Profiles) 1. Baked at50℃ for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2℃ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25℃ in 2.5hrs. 3. Raise temperature to 65±2℃ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25℃ in 2.5hrs,keep at 25℃ for 2 hrs then keep at -10℃ for 3 hrs 4. Keep at 25℃ 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDECJ-STD-020E Classification Reflow Profiles) Condition for 1 cycle Step1：-40±2℃ 30±5min Step2：125±2℃ ≦0.5min Step3：125±2℃ 30±5minNumber of cycles： 500 Measured at room fempraturc after placing for 24±2 hrs.
Vibration		Preconditioning: Run through IR reflow for 3 times. (IPC/JEDECJ-STD-020E Classification Reflow Profiles) Oscillation Frequency: 10Hz～2KHz～10Hz for 20 minutes Equipment： Vibration checker Total Amplitude: 10g Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations)。

<table>
<tr><th>Item</th><th>Performance</th><th>Test Condition</th></tr>
<tr><td>Bending</td><td rowspan="2">Appearance：No damage.
Inductance：within±10% of initial value
Q：Shall not exceed the specification value.
RDC：within ±15% of initial value and shall not exceed the specification value</td><td>Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm
<0805 inch(2012mm):40x100x0.8mm
Bending depth: >=0805 inch(2012mm):1.2mm
<0805 inch(2012mm):0.8mm
duration of 10 sec.</td></tr>
<tr><td>Shock</td><td>
<table>
<tr><th>Type</th><th>Peak value (g's)</th><th>Normal duration (D) (ms)</th><th>Wave form</th><th>Velocity change (Vi)ft/sec</th></tr>
<tr><td>SMD</td><td>50</td><td>11</td><td>Half-sine</td><td>11.3</td></tr>
<tr><td>Lead</td><td>50</td><td>11</td><td>Half-sine</td><td>11.3</td></tr>
</table>
3 shocks in each direction along 3 perpendicular axes(18 shocks).</td></tr>
<tr><td>Solderability</td><td>More than 95% of the terminal electrode should be covered with solder。</td><td>a. Method B1, 4 hrs @155°C dry heat @255°C±5°C
Test time:5 +0/-0.5 seconds.

b. Method D category 3. (steam aging 8hours ± 15 min)@ 260°C±5°C
Test time: 30 +0/-0.5 seconds.</td></tr>
<tr><td>Resistance to Soldering Heat</td><td rowspan="2">Appearance：No damage.
Inductance：within±10% of initial value
Q：Shall not exceed the specification value.
RDC：within ±15% of initial value and shall not exceed the specification value e</td><td>Depth: completely cover the termination
<table>
<tr><th>Temperature(°C)</th><th>Time(s)</th><th>Temperature ramp/immersion and emersion rate</th><th>Number of heat cycles</th></tr>
<tr><td>260 ±5 (solder temp)</td><td>10 ±1</td><td>25mm/s ±6 mm/s</td><td>1</td></tr>
</table></td></tr>
<tr><td>Terminal Strength</td><td>Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles
With the component mounted on a PCB with the device to be tested,applyaforce(>0805inch(2012mm):1kg,<=0805inch(2012 mm):0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.
 
</td></tr>
</table>

Note : When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.

7. Soldering Specifications

(1) Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

(2) Soldering Reflow:

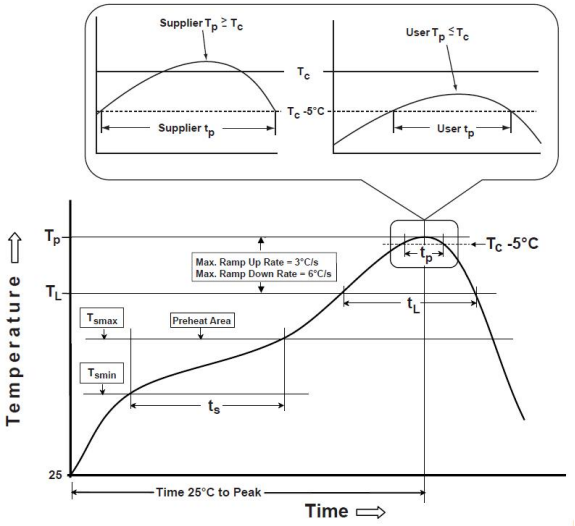
Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

(3) Iron Reflow:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.(Fig. 2)

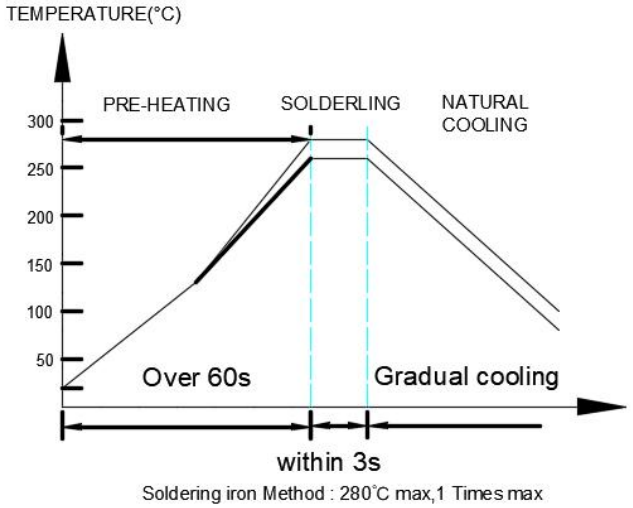
- Preheat circuit and products to 150℃
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 280℃ tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 3sec.

Fig.1 Soldering Reflow



Reflow times: 3 times max

Fig.2 Iron soldering temperature profiles



Soldering iron Method : 280℃ max,1 Times max

Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min(T_{smin}) -Temperature Max(T_{smax}) -Time(t_s)from(T_{smin} to T_{smax})	 150℃ 200℃ 60-120seconds
Ramp-up rate($T_L$to T_p)	3℃/second max.
Liquidus temperature(T_L) Time(t_L)maintained above T_L	217℃ 60-150 seconds
Classification temperature(T_c)	See Table (1.2)
Time(t_p) at Tc- 5℃ (Tp should be equal to or less than Tc.)	*< 30 seconds
Ramp-down rate(T_p to T_L)	6℃ /second max.
Time 25℃ to peak temperature	8 minutes max.

Tp: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) **Tp** should be equal to or less than **Tc.**

* Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

	Package Thickness	Volume mm^3 <350	Volume mm^3 350-2000	Volume mm^3 >2000
PB-Free Assembly	<1.6mm	260℃	260℃	260℃
	1.6-2.5mm	260℃	250℃	245℃
	≥2.5mm	250℃	245℃	245℃

Reflow is referred to standard IPC/JEDEC J-STD-020E。

8. Notes

(1) When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition

(2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.

(3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.

(4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.

(5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.

(6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product. PCB washing tested to MIL-STD-202 Method，and dry it off immediately。

(7) The rated current as listed is either the saturation current or the heating current depending on which value is lower.

(8) If this power choke is dipped in the cleaning agent, such as toluene, xylene, ketone, and ether system, there is a possibility that the performance decreases greatly，and marking disappearnc。

(9) The high power ultrasonic washing may damage the choke body。

(10) Before use，the user should determine whether this product is suitable for their own design，Our company only guarantees that the product meets the requirements of this specification。

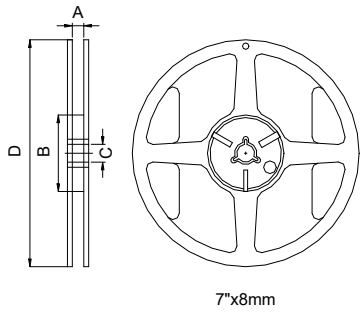
Application Notice

· Storage Conditions
To maintain the solderability of terminal electrodes:
1. TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
2. Temperature and humidity conditions: Less than 40℃ and 60% RH.
3. Recommended products should be used within 12 months form the time of delivery.
4. The packaging material should be kept where no chlorine or sulfur exists in the air.

· Transportation
1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

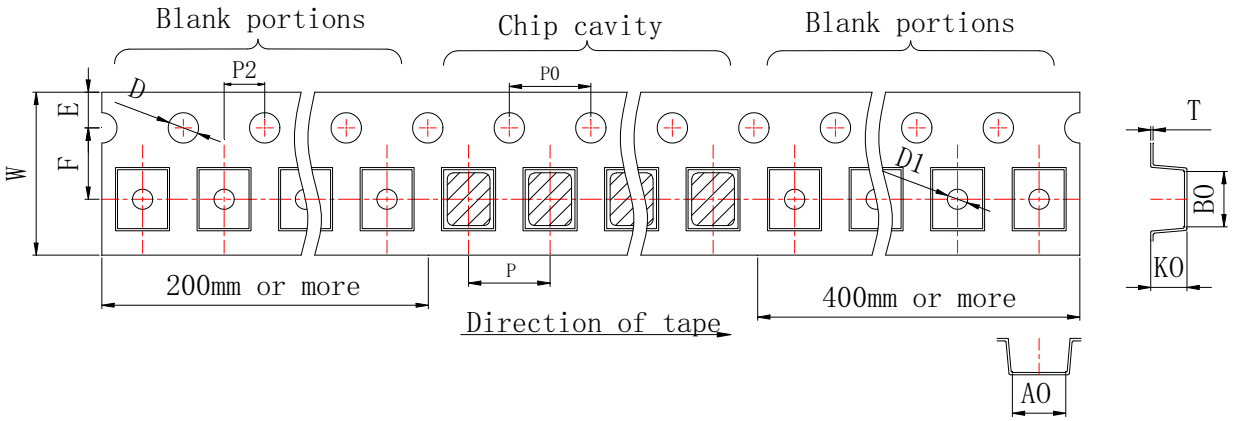
9. Packaging Information

(1) Reel Dimension



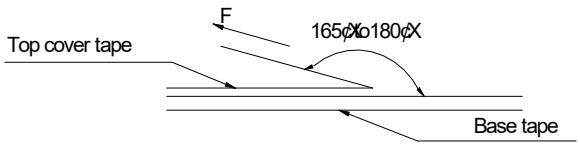
Size	Type	A(mm)	B(mm)	C(mm)	D(mm)
TMIM201610A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0
TMIM201612A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0
TMIM252010A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0
TMIM252012A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0
TMIM322510A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0
TMIM322512A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0
TMIM322520A	7"x8mm	8.4+1.5/-0.0	60±1.0	13+0.5/-0.2	178±2.0

(2)Tape Dimension



Series	B0(mm)	A0(mm)	K0(mm)	W(mm)	P(mm)	P0(mm)	P2(mm)	E(mm)	F(mm)	T(mm)	D/D1(mm)	Packaging Quantity
TMIM201610	2.5±0.1	2.0±0.1	1.2±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.23±0.05	1.5+0.1/-0.0	2000
TMIM201612	2.5±0.1	2.0±0.1	1.35±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.23±0.05	1.5+0.1/-0.0	2000
TMIM252010	2.9±0.1	2.45±0.1	1.35±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.24±0.05	1.5+0.1/-0.0	2000
TMIM252012	2.9±0.1	2.45±0.1	1.35±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.24±0.05	1.5+0.1/-0.0	2000
TMIM322510	3.6±0.1	2.9±0.1	1.4±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.22±0.05	1.5+0.1/-0.0	2000
TMIM322512	3.6±0.1	2.9±0.1	1.4±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.22±0.05	1.5+0.1/-0.0	2000
TMIM322520	3.6±0.1	2.9±0.1	2.2±0.1	8.0±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.75±0.1	3.5±0.1	0.22±0.05	1.5+0.1/-0.0	2000

(3)Tearing Off Force

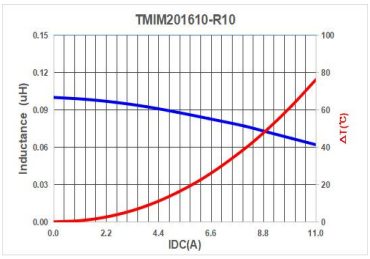


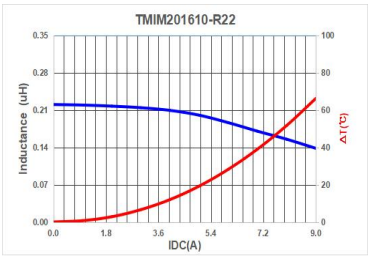
The force for tearing off cover tape is 10 to 100 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-D-2008 of 4.11 stadnard).

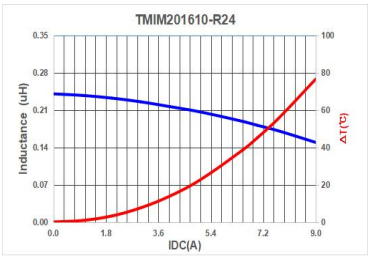
Tearing Speed mm	Room Temp. (℃)	Room Humidity (%)	Room atm (hPa)
300±10	5~35	45~85	860~1060

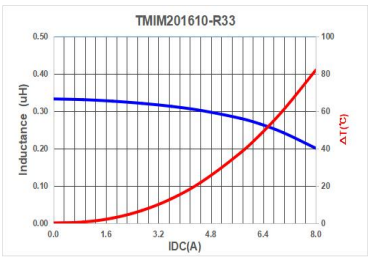
10. Typical Performance Curves

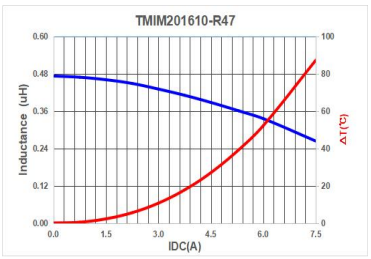
TMIM201610A

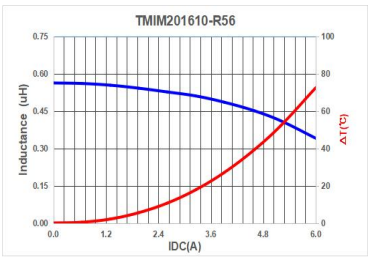


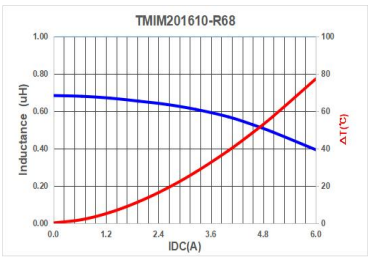


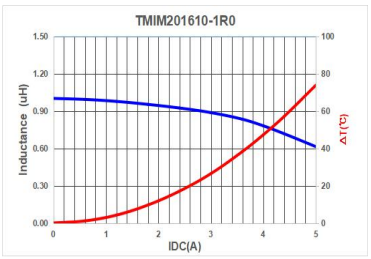


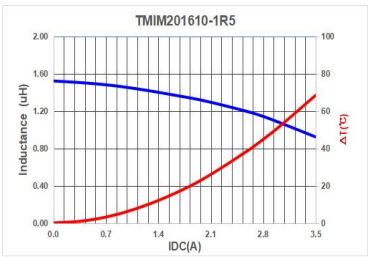


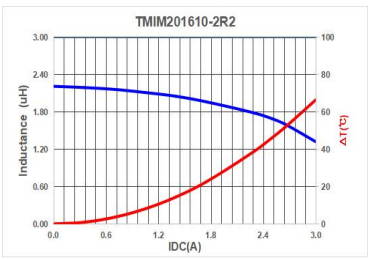


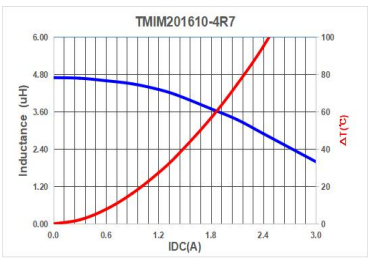




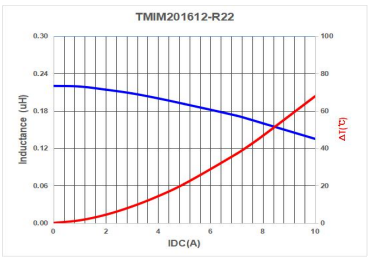


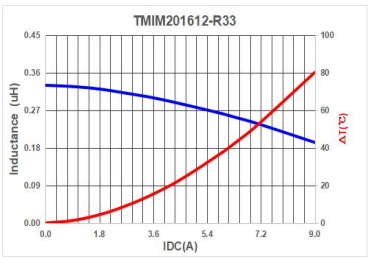


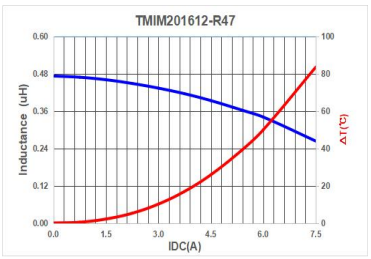


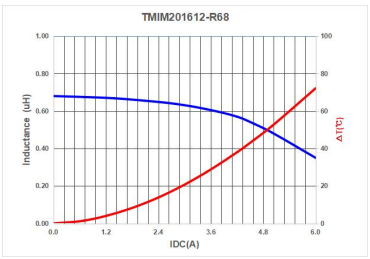


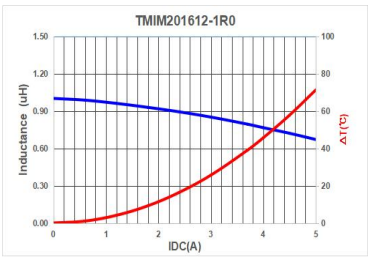
TMIM201612A

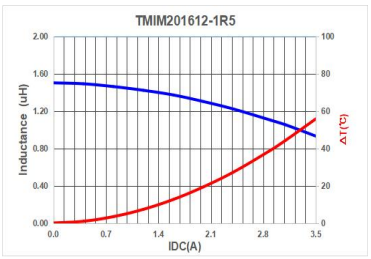


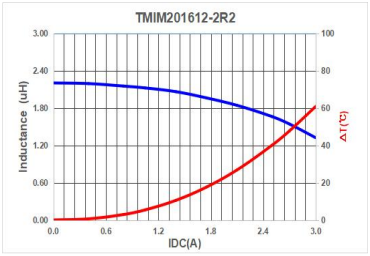




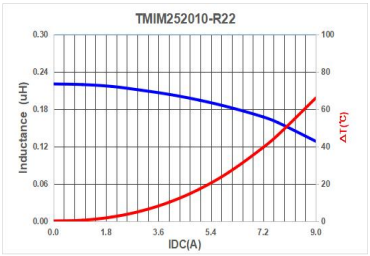


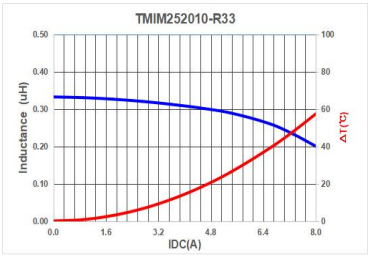


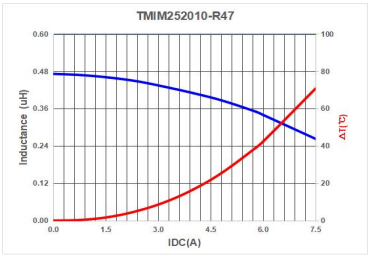


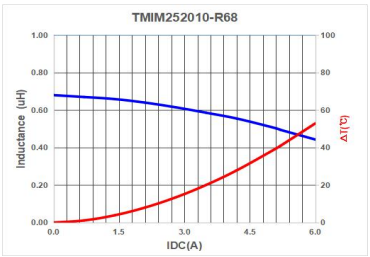


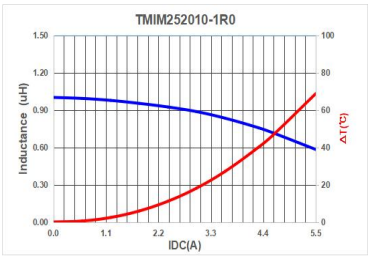
TMIM252010A

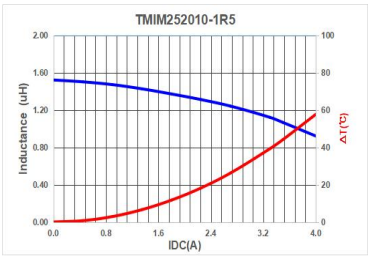


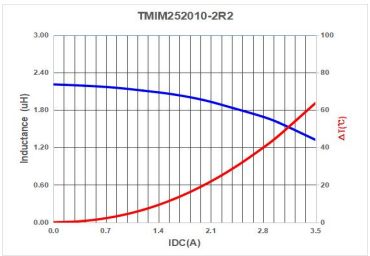


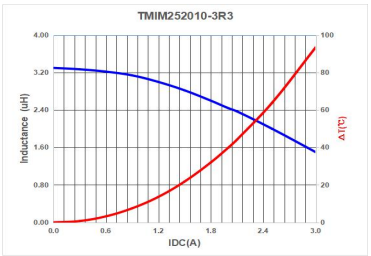




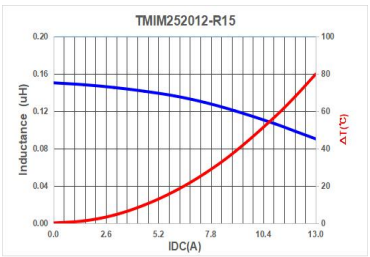


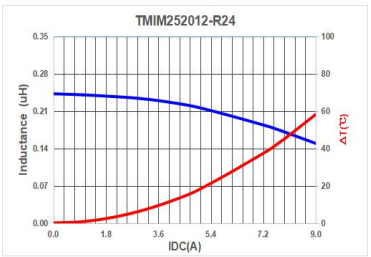


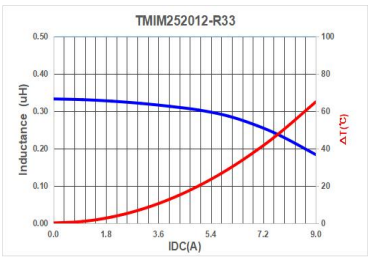


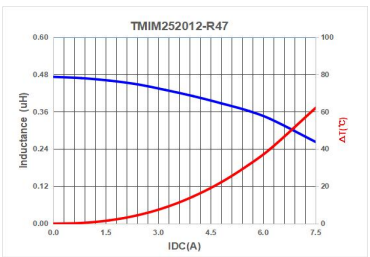


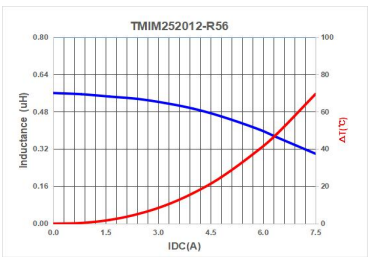
TMIM252012A

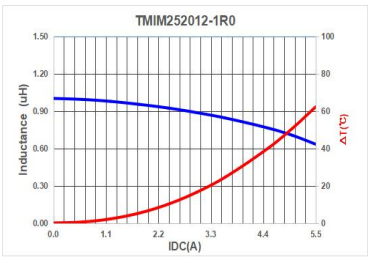


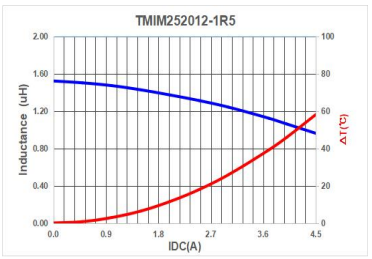


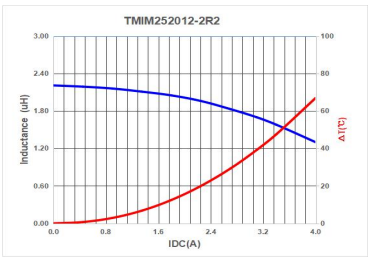


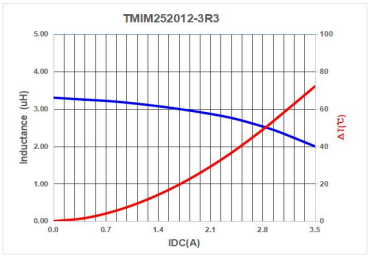


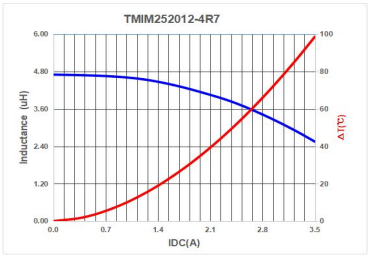




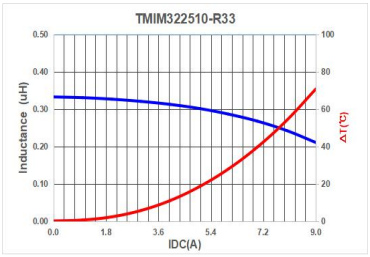


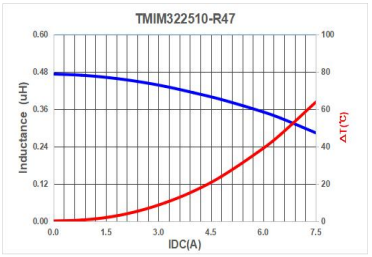


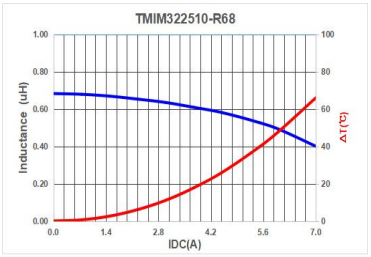


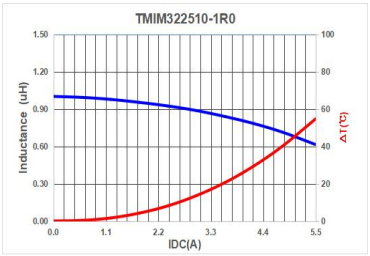


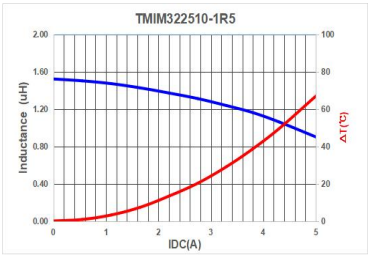
TMIM322510A

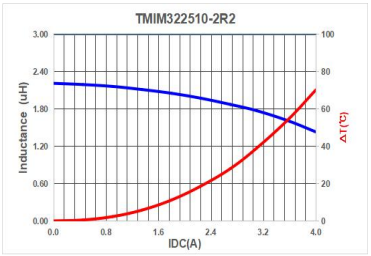


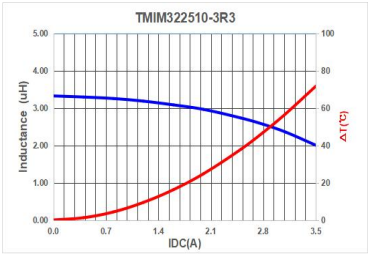


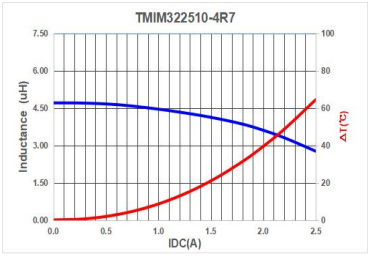




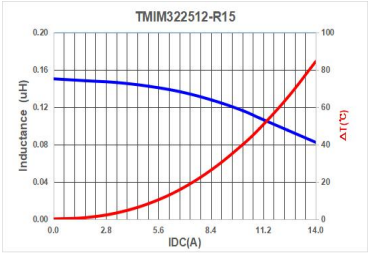


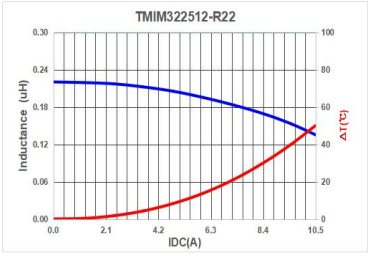


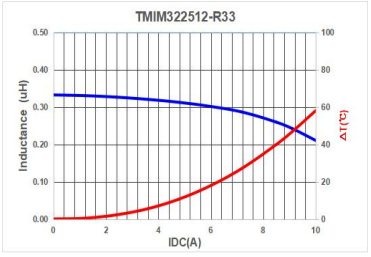


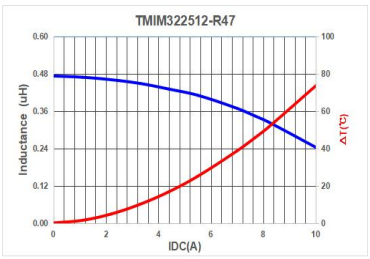


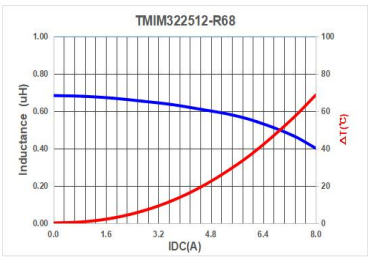
TMIM322512A

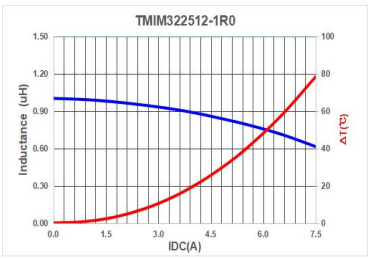


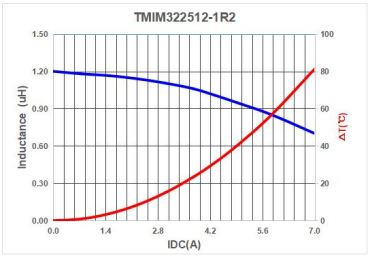


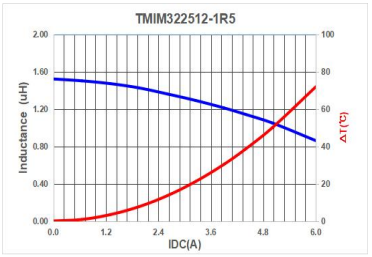


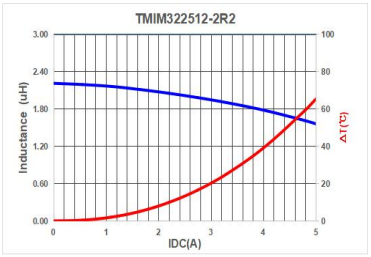


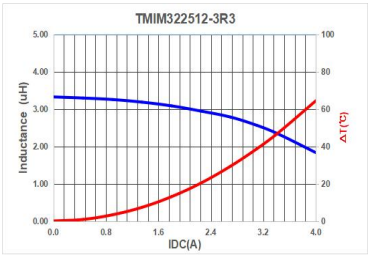


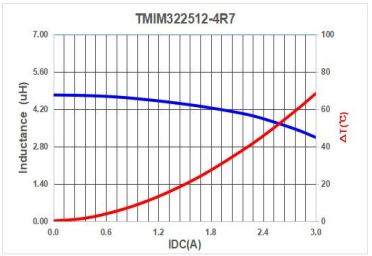












TMIM322520A